KennTherm 7185

Thermal Compound

KennTherm 7185 Thermal Compound is a non-silicone grease and metal grease with very low thermal impedance and long-term stability. The proprietary- formulated thermal compound with appropriate viscosity and good consistency can be spread easily and evenly. It can be stored in room temperature without special treatment.

KennTherm 7185 serves as an effective thermal interface material for heat sink devices where efficient cooling as well as long-term stability is required.

Features

- > Excellent performance
- > Excellent long-term stability
- Non-corrosive
- > No special requirements forstorage
- > Easy to apply and less to use
- > No "burn-in" time required
- > Low dry-out
- > Not electrically conductive



Specifications

Properties		Test Methods	Units	Typical value
Color				Gray
Consistency		ASTM D217		170
Specific Gravity		ASTM D1475	g/cm ³	2.5
Viscosity		BrookField CVE #7 @12RPM	Cps	300K~500K
Thermal Properties				
Thermal Conductivity		ASTM D5470	W/m-K	3.5
Thermal Impedance		ASTM D5470	K-in ² /W	0.013~0.023
Dry-Out test		240 Hours at 363K	Weight%	0.03
Electrical Properties				
Dielectric constant	298K@1000 Hz	ASTM D-150		4.67
	298K@100K Hz	ASTM D-150		2.84
Dissipation factor	298K@1000 Hz	ASTM D-150		0.43
	298K@100K Hz	ASTM D-150		0.15
Dielectric Strength		ASTM D-149	kV/mm	1.5